

INV100FQ030A

100V Bi-directional Enhancement-mode Power Transistor

INV100FQ030A

1. General description

Bi-directional GaN-on-Silicon enhancement mode high-electron-mobility-transistor (HEMT) in FCQFN with 4.0 mm x 6.0 mm package size.

2. Features

- Bi-directional blocking capability
- GaN-on-Silicon E-mode HEMT technology
- Ultra-low on resistance

3. Applications

- BMS battery protection
- High side load switch in bi-directional converter
- Switch circuits in multiple power supplier system

4. Key performance parameters

Table 1 Key performance parameters at $T_J = 25\text{ }^\circ\text{C}$

Parameter	Value	Unit
$V_{DD, \max}$	100	V
$R_{DD(\text{on}), \max}$ @ $V_G = 5\text{ V}$	3.2	m Ω
$Q_{G, \text{typ}}$ @ $V_{DD} = 50\text{ V}$	90	nC
$I_{D, \text{DC}}$	100	A

5. Pin information

Table 2 Pin information

Pin	Pin description	Pin function
1,2,25	Gate	Driver Gate
3-7,9,11,21,23	Drain1	Power Drain1
8,10,12-20,22,24	Drain2	Power Drain2

Table 3 Ordering information

Type/Ordering Code	Package	Product Code
INV100FQ030A	FCQFN 4X6	J25

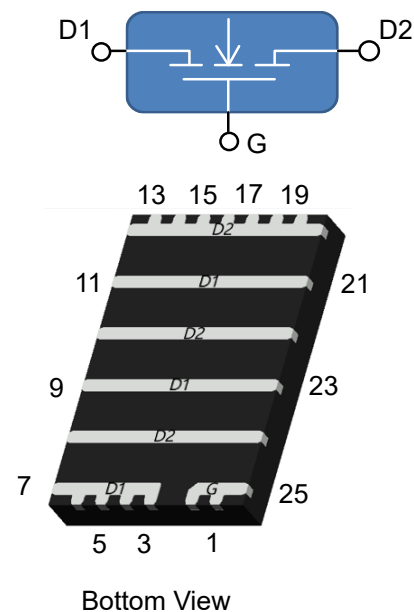


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6. Maximum ratings

at $T_J = 25\text{ °C}$ unless otherwise specified.

Continuous application of maximum ratings can deteriorate transistor lifetime. For further information, contact Innoscience sales office.

Table 4 Maximum ratings

SYMBOL	PARAMETER	MAX	UNIT
V_{DD}	Drain1-to-Drain2 Voltage or Drain2-to-Drain1 Voltage	100	V
$V_{DD(tr)}$	Drain1-to-Drain2 Voltage or Drain2-to-Drain1 Voltage (up to 300,000 5ms pulse at 150 °C)	120	V
V_{DG}	Drain1-to-Gate Voltage or Drain2-to-Gate Voltage	100	V
V_{GD}	Gate-to-Drain1 Voltage or Gate-to-Drain2 Voltage	6	V
I_D	Continuous Drain Current	100	A
I_{DM}	Pulsed Drain Current (25°C, $T_{Pulse} = 100\text{ }\mu\text{s}$)	320	A
T_J	Operating Temperature	-40 to 150	°C
T_{STG}	Storage Temperature	-40 to 150	°C

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7. Thermal characteristics

Table 5 Thermal characteristics

SYMBOL	PARAMETER	TYP	UNIT	Note/Test Condition
$R_{\theta JC}$	Thermal Resistance, Junction to Case	13.96	°C/W	
$R_{\theta JB}$	Thermal Resistance, Junction to Board	1.92	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ¹	57.56	°C/W	
T_{sold}	Maximum reflow soldering temperature	260	°C	MSL3

Note 1: $R_{\theta JA}$ is determined with the device mounted on one square inch of copper pad, single layer 2 oz copper on FR4 board.

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8. Electric characteristics

at $T_J = 25\text{ }^\circ\text{C}$, unless specified otherwise

Table 6 Static characteristics

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT	TEST CONDITIONS
BV_{D1D2}	Drain1-to-Drain2 Breakdown Voltage	100	-	-	V	$V_{D2} = V_G = 0\text{ V}$, $I_{D1D2} = 500\text{ }\mu\text{A}$
BV_{D2D1}	Drain2-to-Drain1 Breakdown Voltage	100	-	-	V	$V_{D1} = V_G = 0\text{ V}$, $I_{D2D1} = 500\text{ }\mu\text{A}$
I_{D1D2}	Drain1-to-Drain2 Leakage	-	1	4	μA	$V_{D2} = V_G = 0\text{ V}$, $V_{D1} = 80\text{ V}$
I_{D2D1}	Drain2-to-Drain1 Leakage	-	1	4	μA	$V_{D1} = V_G = 0\text{ V}$, $V_{D2} = 80\text{ V}$
I_{GD}	Gate-to-Drain Forward Leakage	-	1	4	μA	$V_{D1} = V_{D2} = 0\text{ V}$, $V_G = 5\text{ V}$
	Gate-to-Drain Forward Leakage	-	2	8	μA	$V_{D1} = V_{D2} = 0\text{ V}$, $V_G = 5.5\text{ V}$
	Gate-to-Drain Forward Leakage	-	4.5	18	μA	$V_{D1} = V_{D2} = 0\text{ V}$, $V_G = 6\text{ V}$
$V_{GD1(TH)}$	Gate Threshold Voltage	0.8	1.1	2.5	V	$V_{D1} = 0\text{ V}$, $V_{D2} = V_G$, $I_{D2D1} = 13\text{ mA}$
$V_{GD2(TH)}$	Gate Threshold Voltage	0.8	1.1	2.5	V	$V_{D2} = 0\text{ V}$, $V_{D1} = V_G$, $I_{D1D2} = 13\text{ mA}$
$R_{D1D2(on)}$	Drain1-to-Drain2 On-state Resistance	-	2.5	3.2	m Ω	$V_{D2} = 0\text{ V}$, $V_{GD} = 5\text{ V}$, $I_{D1D2} = 25\text{ A}$
$R_{D2D1(on)}$	Drain2-to-Drain1 On-state Resistance	-	2.5	3.2	m Ω	$V_{D1} = 0\text{ V}$, $V_{GD} = 5\text{ V}$, $I_{D2D1} = 25\text{ A}$

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Table 7 Dynamic characteristics

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT	TEST CONDITIONS
C _{ISS}	Input Capacitance	-	3300	-	pF	V _G = 0 V, V _D = 50 V
C _{OSS}	Output Capacitance	-	830	-		
C _{RSS}	Reverse Transfer Capacitance	-	400	-		
R _G	Gate Resistance	-	5	-	Ω	f = 5 MHz, Open drain
Q _G	Total Gate Charge	-	90	-	nC	V _D = 50 V, V _G = 5 V, I _D = 25 A
Q _{GD1}	Gate-to-Drain1 Charge (V _{D2D1} =50V)	-	7	-		V _{D1} = 0, V _{D2} = 50 V, I _{D2D1} = 25 A
Q _{GD1}	Gate-to-Drain1 Charge (V _{D1D2} =50V)	-	65	-		V _{D2} = 0, V _{D1} = 50 V, I _{D1D2} = 25 A
Q _{GD2}	Gate-to-Drain2 Charge (V _{D1D2} =50V)	-	7	-		V _{D2} = 0, V _{D1} = 50 V, I _{D1D2} = 25 A
Q _{GD2}	Gate-to-Drain2 Charge (V _{D2D1} =50V)	-	65	-		V _{D1} = 0, V _{D2} = 50 V, I _{D2D1} = 25 A
Q _{OSS}	Output Charge	-	85	-		V _G = 0 V, V _D = 50 V

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9. Electric characteristics diagrams

at $T_J = 25^\circ\text{C}$ unless otherwise specified.

Note: In Charts, VD1D2 can be VD2D1 with same characteristic chart due to Bi-directional feature.

Fig. 1 Typical Output Characteristics ($T_J=25^\circ\text{C}$)

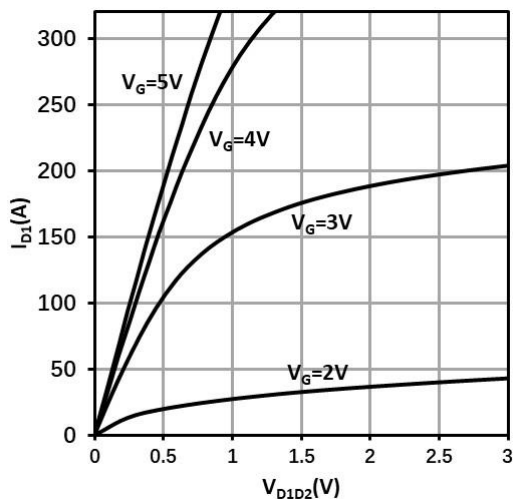


Fig. 2 Typical Output Characteristics ($T_J=125^\circ\text{C}$)

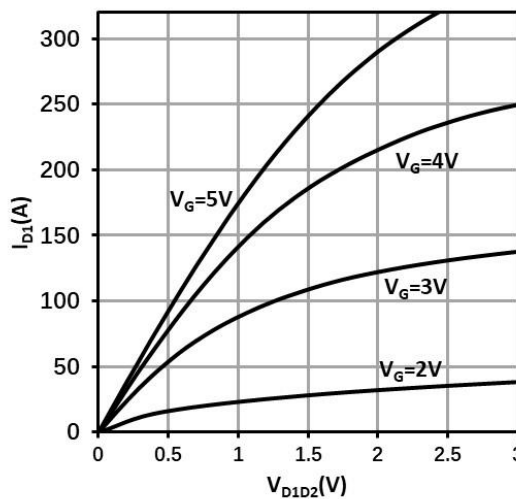


Fig.3 Typical Drain On-state Resistance ($T_J=25^\circ\text{C}$)

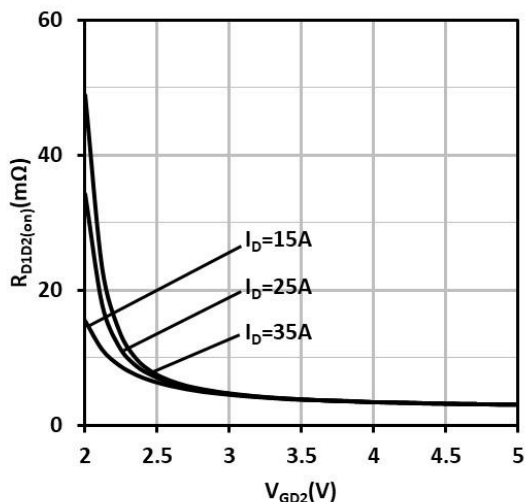
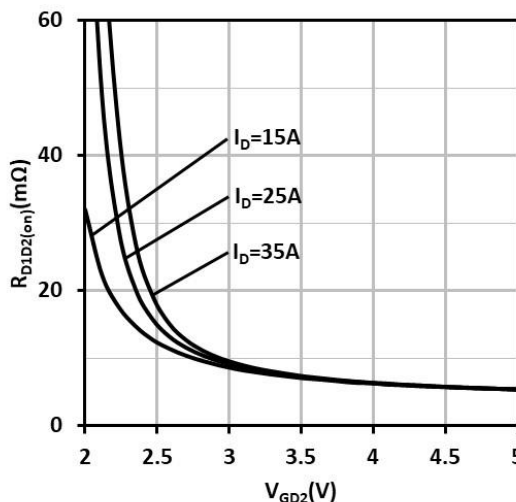


Fig. 4 Typical Drain On-state Resistance ($T_J=125^\circ\text{C}$)



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Fig. 5 Normalized On-State Resistance vs. Temp.

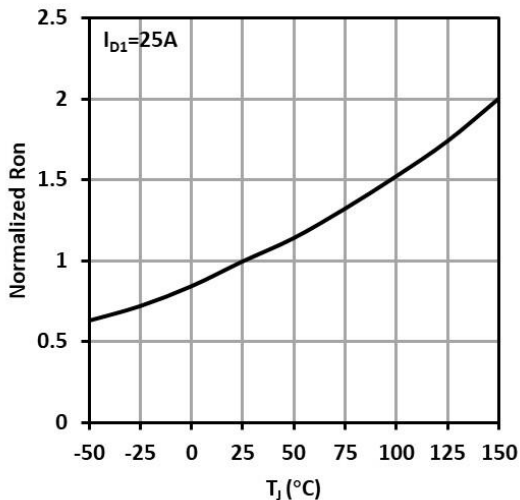


Fig. 6 Typical Transfer Characteristics

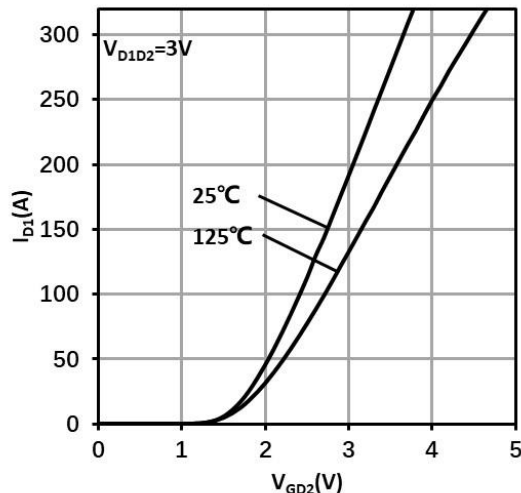


Fig. 7 Typ. Reverse Drain1-Drain2 Characteristics ($V_{GD2} \leq 0, T_J = 25^\circ\text{C}$)

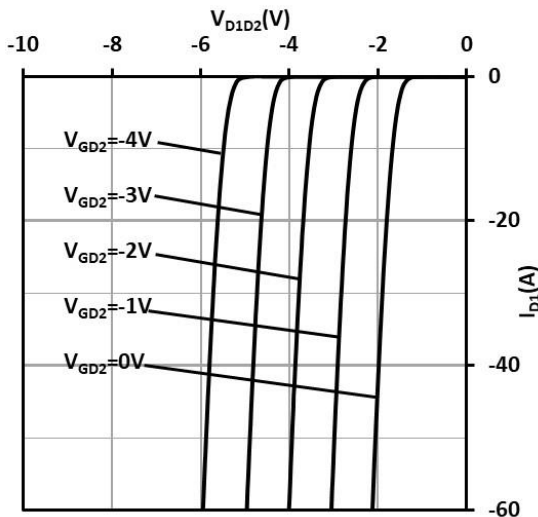
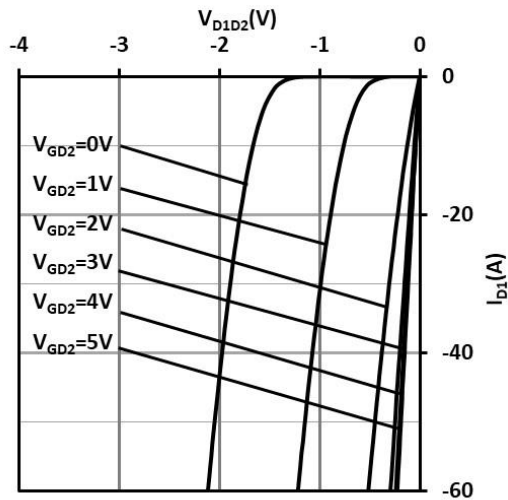


Fig. 8 Typ. Reverse Drain1-Drain2 Characteristics ($V_{GD2} \geq 0, T_J = 25^\circ\text{C}$)



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Fig. 9 Typ. Reverse Drain1-Drain2 Characteristics ($V_{GD2} \leq 0$, $T_J = 125^\circ\text{C}$)

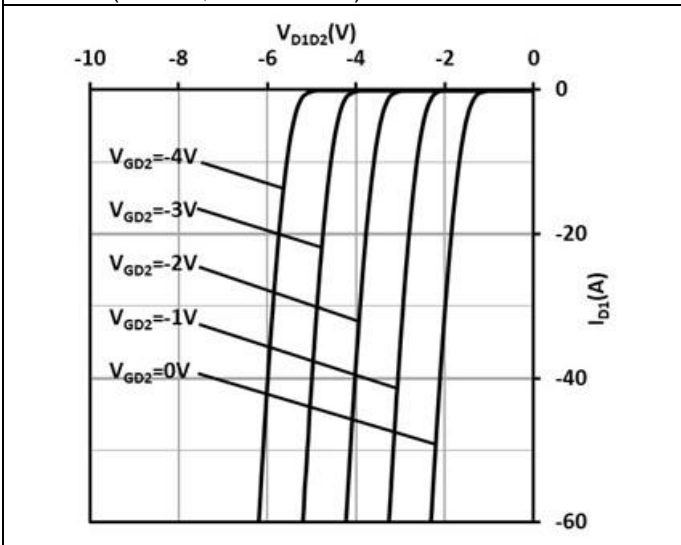


Fig. 10 Typ. Reverse Drain1-Drain2 Characteristics ($V_{GD2} \geq 0$, $T_J = 125^\circ\text{C}$)

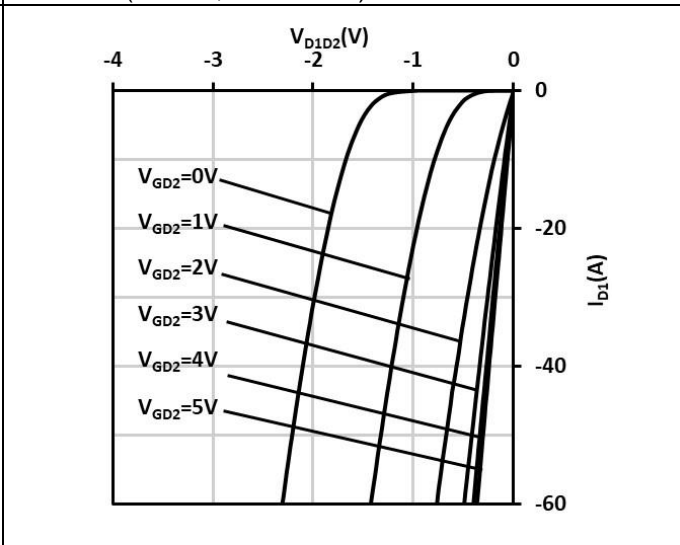


Fig. 11 Typ. Capacitances Characteristics

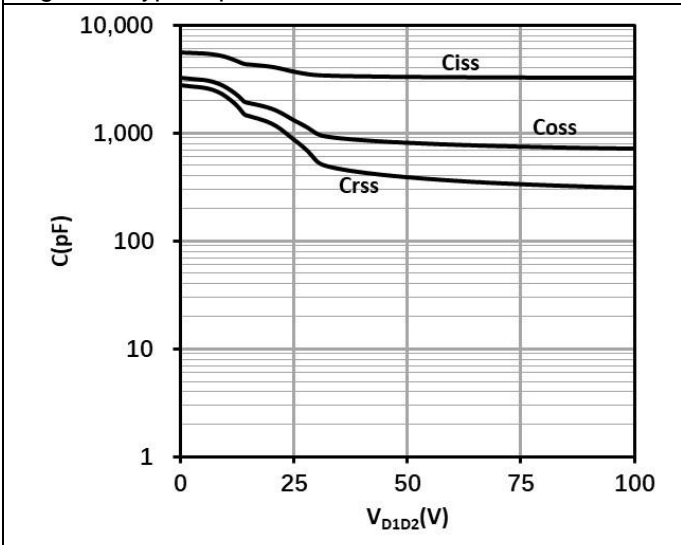


Fig. 12 Typ. Gate Charge

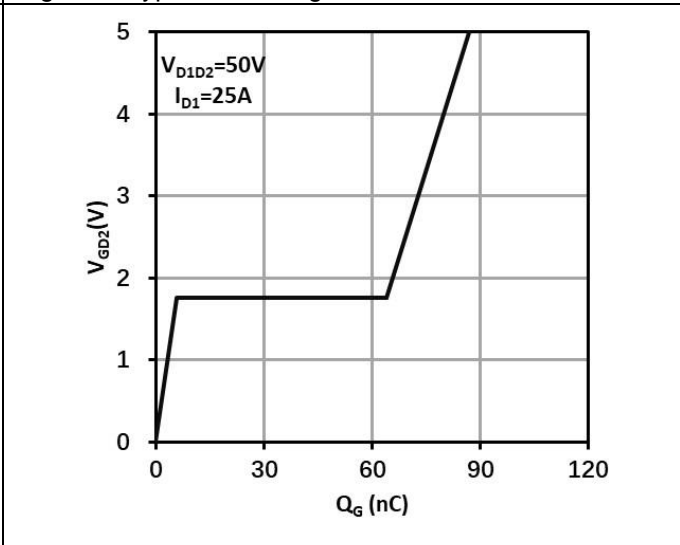


Fig. 13 Normalized Threshold Voltage vs. Temp.

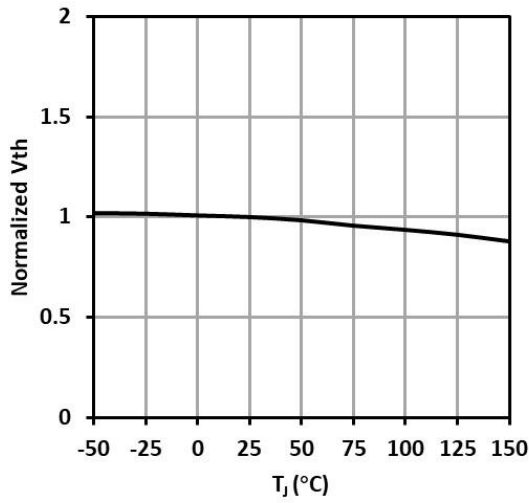


Fig. 14 Output Charge

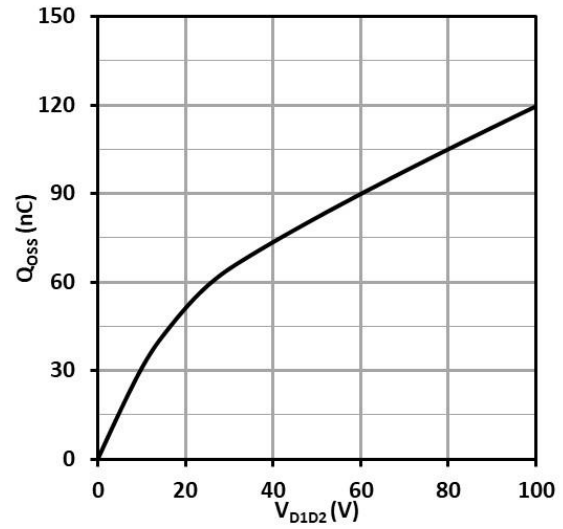


Fig. 15 Output Capacitance Stored Energy

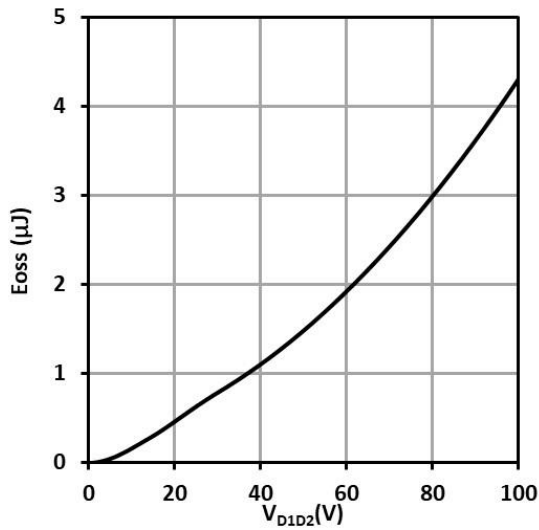
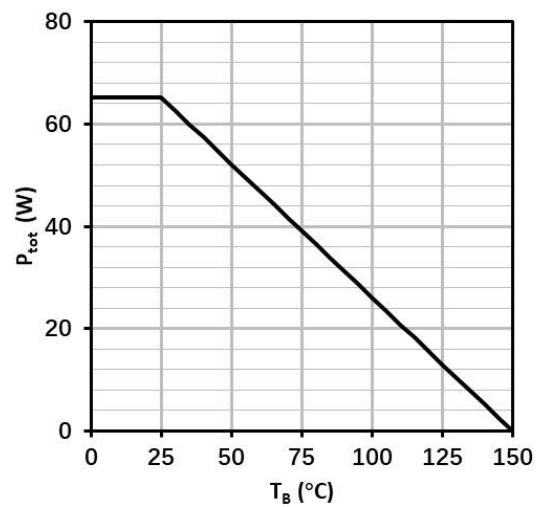


Fig. 16 Power Dissipation



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Fig. 17 Safe Operating Area

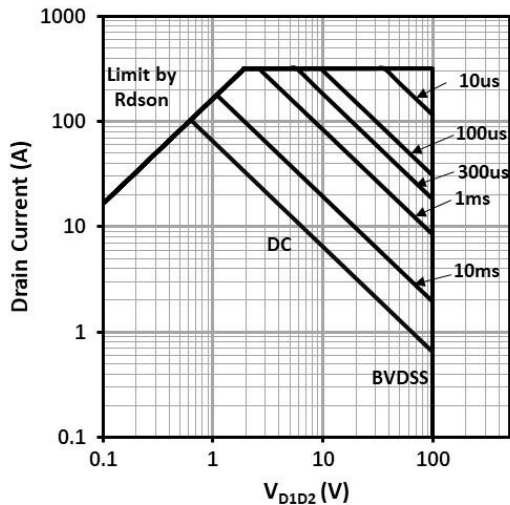
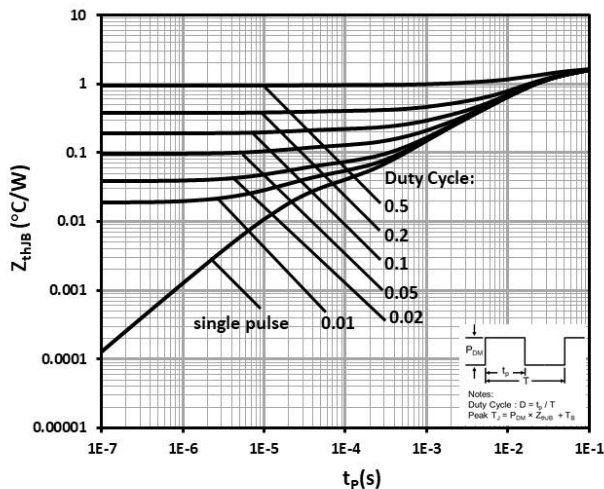


Fig. 18 Max. Transient Thermal Impedance

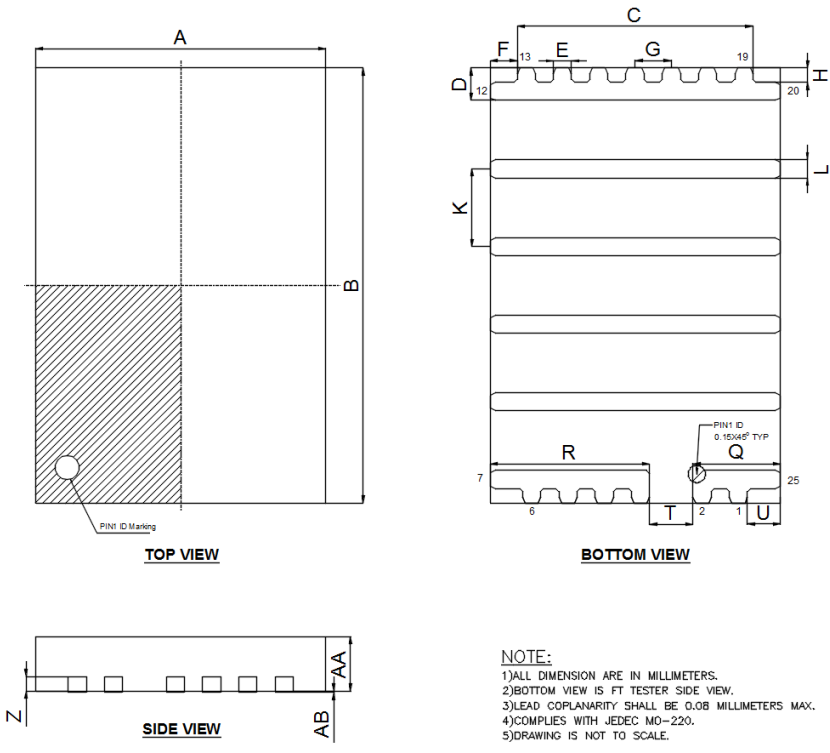


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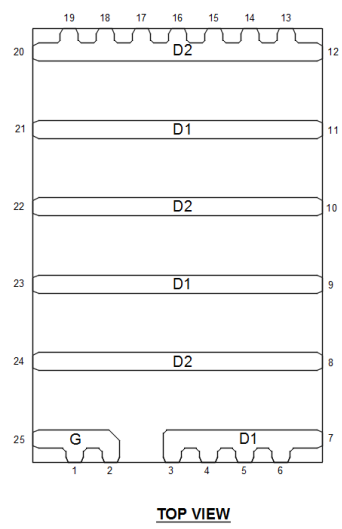
10. Package outlines

Package Reference

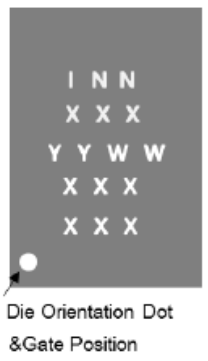


SYMBOL	MILLIMETER			NOTE
	MIN	NOM	MAX	
A	3.9	4.0	4.1	
B	5.9	6.0	6.1	
C	3.15	3.25	3.35	
D	0.35	0.45	0.55	3X
E	0.20	0.25	0.30	13X
F	0.375 REF			2X
G	0.5 BASIC			10X
H	0.2 REF			3X
K	1.07 BASIC			6X
L	0.20	0.25	0.30	4X
Q	1.1	1.2	1.3	
R	2.1	2.2	2.3	
T	0.55	0.60	0.65	
U	0.45 REF			2X
Z	0.203 REF			7X
AA	0.75	0.85	0.95	
AB	0.00	0.02	0.05	

PIN configuration



Marking Reference



Row	Description	Example
Row 1	Company name	INN
Row 2	Product code	XXX
Row 3	Date code	YYWW
Row 4	Lot No	XXX
Row 5	Lot No	XXX

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11. Reel information

NOTES:

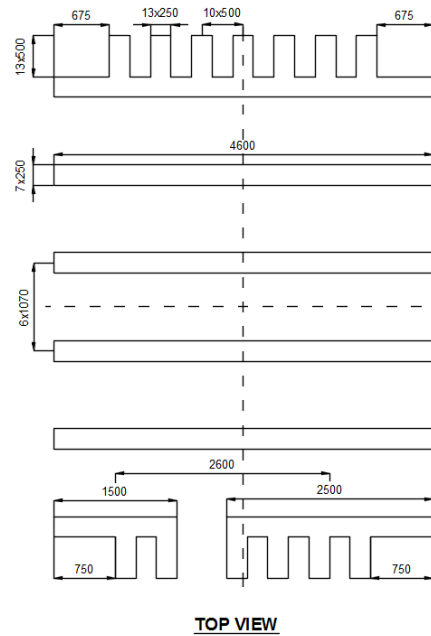
1. CARRIER TAPE COLOR: BLACK.
2. COVER TAPE WIDTH: 13.3±0.10.
3. COVER TAPE COLOR: TRANSPARENT.
4. 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE ±0.20 MAX.
5. CAMBER NOT TO EXCEED 1MM IN 100MM.
6. MOLD# QFN/DFN/MIS6X4X0.75/0.85.
7. ALL DIMS IN MM.
8. BAN TO USE THE ENVIRONMENT-RELATED SUBSANCES OF JCET PRESCRIBING.

NOTES:

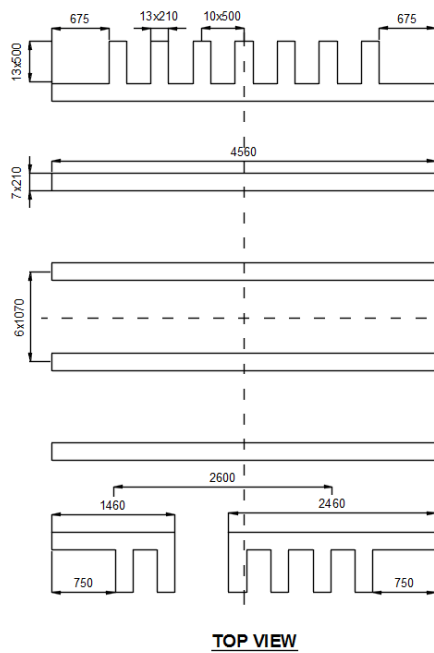
1. 2500 UNITS PER TRAY.
2. COLOR: WHITE.
3. ALL DIM IN mm.
4. GENERAL TOLERANCE±0.25.
5. BAN TO USE THE ENVIRONMENT-RELATED SUBSANCES OF JCET PRESCRIBING.
6. THE DERECTION OF VIEW:

12. Land pattern

Recommended Land Pattern



Recommended Stencil drawing



13. Revision history

Major changes since the last revision

Revision	Date	Description of changes
1.0	2023-11-24	Version 1.0 release

Important Notice

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